

ETCH TO EDGE 3 MILS.
SOLDER FILLET BOARD ETCH TO
CONNECTOR TOP AND BOTTOM.
2 PLACES


SEE NOTE 5
FOR SCREW AND STANDOFF INSTALLATION.
(2 PLACES)

SEE NOTE 4

ASSEMBLY NOTES:

1. BOARD ACCEPTABILITY PER ANALOG DEVICES, INC. SPECIFICATION TST00119 (LATEST REVISION).
2. REPAIRS PER IPC-7711/21(LATEST REVISION) ARE ALLOWED.
3. REPAIRS ARE NOT ALLOWED IN SOLDERMASK FREE AREAS ON EITHER SIDE OF THE BOARD.
4. U22 IS A COMBO FOOTPRINT. AD4080 WILL BE SUPPLIED AND INSTALLED ON IT.
5. INSTALL SCREW (M025339) ON PRIMARY SIDE AND STANDOFF (M025474) ON THE SECONDARY SIDE.
6. RoHS COMPLIANCE: ASSEMBLY VENDOR SHOULD ASSURE COMPLIANCE WITH LEAD-FREE AND RoHS PCB ASSEMBLY STANDARDS (EU RoHS DIRECTIVE 2002/95/EC).
7. BOARDS TO BE SHIPPED SINGULATED AFTER ASSEMBLY PROCESS. SMOOTHEN EDGES AND FREE FROM BURRS AFTER DEPANELIZATION PROCESS.

PRIMARY SIDE

UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES TOLERANCES DECIMALS FRACTIONS ANGLES .XX -.010 --1/32 -- 2 .XXX -.005 .XXXX -.0050			APPROVAL		DATE		<div><div></div><div>ANALOG DEVICES</div></div>		WWM DIVISION 804 WOBURN STREET WILMINGTON, MA 01887					
			TEMPLATE ENGINEER				TITLE ASSEMBLY EVAL - AD408x FMCZ CUSTOMER EVAL BOARD Z							
			HARDWARE SERVICES M. VICEDO		02FEB22									
			HARDWARE SYSTEMS											
MATERIAL			TEST ENGINEER											
			COMPONENT ENGINEER A. GIRON		02FEB22									
			TEST PROCESS											
			HARDWARE RELEASE K. JABATAN		02FEB22									
FINISH			DESIGNER M. VICEDO		02FEB22		SIZE		FSCM NO		DRAWING NUMBER		REV	
			PTD ENGINEER S. KOWALIK		02FEB22									
			CHECKER											
DO NOT SCALE DWG							SCALE		1/1				SHEET 1 OF 2	

ART FILM - array2



4

3

2

1

D

D

C

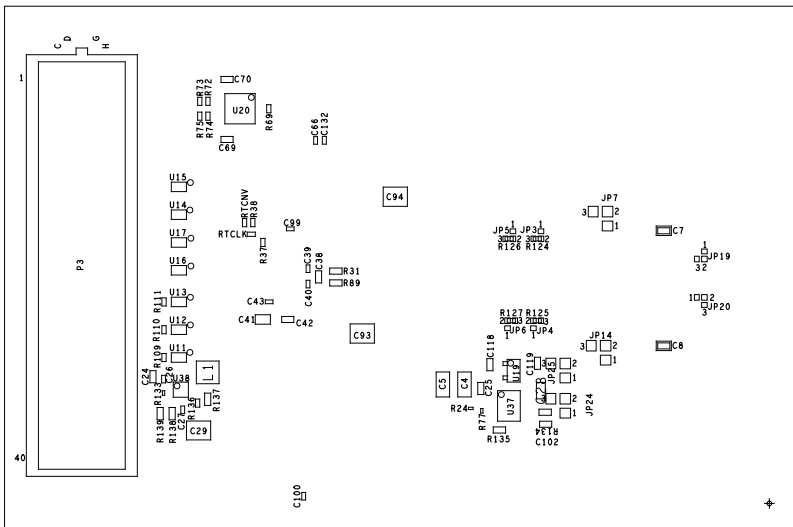
C

B

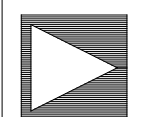
B

A

A



SECONDARY SIDE

		ANALOG DEVICES		WWM DIVISION 804 WOBURN STREET WILMINGTON, MA 01887	
		SIZE	FSCM NO	DRAWING NUMBER	REV
C		24355	01-069798	C	
SCALE		1/1	SHEET 2 OF 2		

ART FILM - array2



4

3

2

1